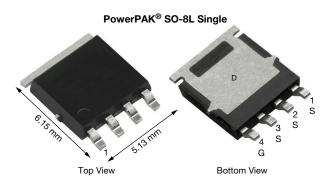




# N-Channel 100 V (D-S) MOSFET

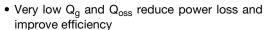


PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.009			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0106			
Q <sub>g</sub> typ. (nC)	26.5			
I <sub>D</sub> (A) <sup>a</sup>	56.7			
Configuration	Single			

ORDERING INFORMATION

### **FEATURES**

TrenchFET® Gen IV power MOSFET





- Flexible leads provide resilience to mechanical stress
- 100 % R<sub>a</sub> and UIS tested
- Q<sub>ad</sub>/Q<sub>as</sub> ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

69.4

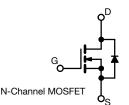
3.2 b, c

-55 to +150

260

### **APPLICATIONS**

- Synchronous rectification
- High power density DC/DC
- DC/AC inverters
- Boost converter
- · LED backlighting



Package	PowerPAK SO-8L				
Lead (Pb)-free and halogen-free		SiJ4108DP-T1-GE3			
ABSOLUTE MAXIMUM RATINGS	6 (T <sub>A</sub> = 25 °C, unles	ss otherwise note	ed)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	100	V	
Gate-source voltage		V <sub>GS</sub>	± 20	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		56.7		
	T <sub>C</sub> = 70 °C		45.3		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		12.1 b, c	A	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	150	^	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	1	63.1		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	4.5 b, c		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	25		
Single pulse avalanche energy	L = 0.1 IIII	E <sub>AS</sub>	31.25	mJ	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W	
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	1.3	1.8		

 $P_{\mathsf{D}}$ 

T<sub>J</sub>, T<sub>stg</sub>

 $T_C = 25 \, \overline{^{\circ}C}$ 

T<sub>C</sub> = 70 °C

 $T_A = 25 \, ^{\circ}C$ 

T<sub>A</sub> = 70 °C

#### Notes

- a.  $T_C = 25 \, ^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 65 °C/W

Operating junction and storage temperature range

Soldering recommendations (peak temperature) d, e

W

°C

Maximum power dissipation



# Vishay Siliconix

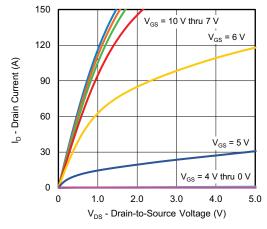
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	100	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 1 mA	-	63	-	>//00	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.3	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	-	-	1		
		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 75 °C	-	-	15	μA	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.0075	0.009	Ω	
		$V_{GS} = 7.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0085	0.0106		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	-	70	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	2440	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	255	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	16.2	-		
Tatal nata abanna		V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	34.5	52		
Total gate charge	Qg		-	26.5	40	0	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 15 \text{ A}$	-	12	-	nC	
Gate-drain charge	Q <sub>gd</sub>		-	5.3	-		
Output charge	Q <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$	-	46	-		
Gate resistance	$R_g$	f = 1 MHz	0.3	0.8	1.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	_	
Rise time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_{L} = 3.33 \Omega$	-	7	14		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 15 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	25	50		
Fall time	t <sub>f</sub>		-	6	12		
Turn-on delay time	t <sub>d(on)</sub>		-	18	36	ns	
Rise time	t <sub>r</sub>	$\begin{aligned} V_{DD} &= 50 \text{ V}, \text{ R}_L = 3.33 \Omega \\ I_D &\cong 15 \text{ A},  V_{GEN} = 7.5 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	-	8	16		
Turn-off delay time	t <sub>d(off)</sub>		-	22	44		
Fall time	t <sub>f</sub>		-	7	14		
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	63.1	^	
Pulse diode forward current ( $t_p = 100 \mu s$ )	I <sub>SM</sub>		-	-	150	A	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 5 A	-	0.75	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	42	84	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	55	110	nC	
Reverse recovery fall time	ta	$T_J = 25  ^{\circ}C$	-	26	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	16	-		

#### Notes

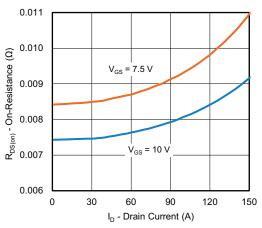
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

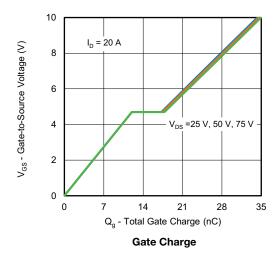


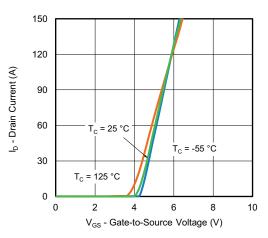


## **Output Characteristics**

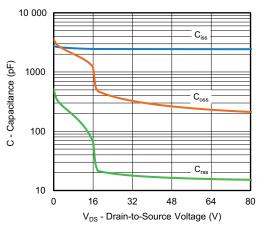


On-Resistance vs. Drain Current

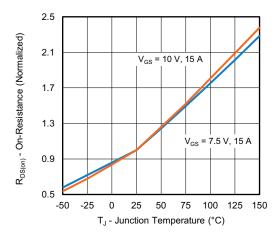




**Transfer Characteristics** 

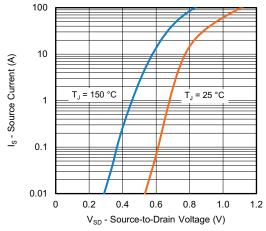


Capacitance

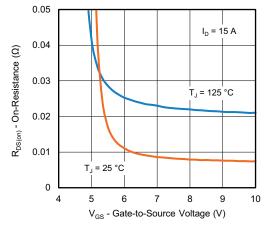


On-Resistance vs. Junction Temperature

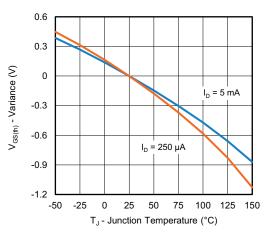




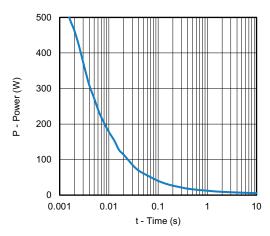
## Source-Drain Diode Forward Voltage



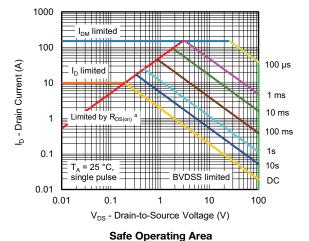
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



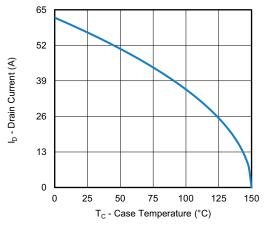
Single Pulse Power, Junction-to-Ambient



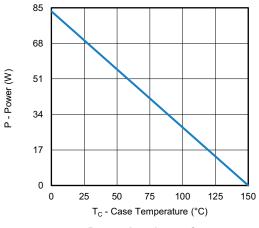
#### Note

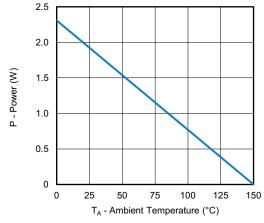
a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





Current Derating a





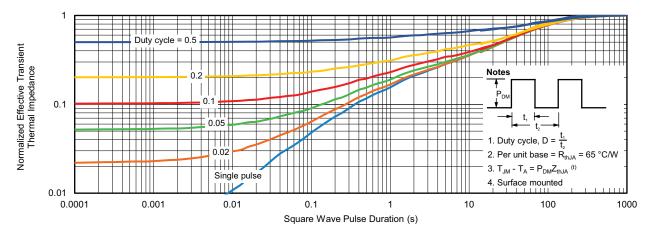
Power, Junction-to-Case

Power, Junction-to-Ambient

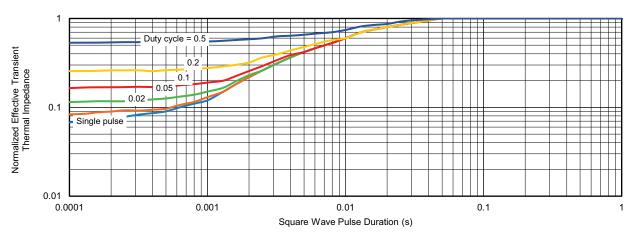
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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